| | Туре | Hits | Search Text | DBs | Time Stamp |
|----|------|-------|--|--|------------------|
| 13 | BRS | 81 | ((second! or another or addition\$ or third) near2 (anneal\$4 or heat\$4 or thermal\$4)) near8 ((ferroelectric or perovskite or PZT or (lead adj zirconium adj titanate))) | | 2003/10/07 17:17 |
| 14 | BRS | 19732 | third near2 (anneal\$4 or heat\$4 or thermal\$4) | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:07 |
| 15 | BRS | 19879 | (RTA or RTP or (rapid adj thermal\$4 adj anneal\$4) or (rapid adj thermal\$4 adj process)) | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:07 |
| 16 | BRS | 3432 | <pre>(third near2 (anneal\$4 or heat\$4 or thermal\$4))</pre> | EPO; | 2004/12/22 16:07 |

| | Туре | Hits | Search Text | DBs | Time Stamp |
|----|------|-------|--|--|------------------|
| 17 | BRS | 21 | adj anneal\$4) or (rapid adj thermal\$4 adj process))) and ((second! or another or addition\$4) near2 (third near2 (anneal\$4 | DERWEN | 2004/12/22 16:07 |
| 18 | BRS | 15574 | (lead adj zirconium adj titanate) or PZT | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:07 |
| 19 | BRS | | (second! or another or addition\$ or third) near2 (anneal\$4 or heat\$4 or thermal\$4) | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:07 |
| 20 | BRS | 62526 | (ferroelectric or perovskite or PZT or (lead adj zirconium adj titanate)) | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | |

| | Туре | Hits | Search Text | DBs | Time Stamp |
|----|------|------|--|--|------------|
| 21 | BRS | 77 | process))) and ((second! or another or addition\$4) near2 (third near2 (anneal\$4 | PGPUB; USPAT; EPO; JPO; DERWEN | |
| 22 | BRS | 6 | adj anneal\$4) or (rapid adj thermal\$4 adj process))) and ((second! or another or addition\$4) near2 (third near2 (anneal\$4 or heat\$4 | DERWEN | |
| 23 | BRS | 3 | (third near2 (anneal\$4 or heat\$4 or thermal\$4)) near8 ((lead adj zirconium | EPO; | |
| 24 | BRS | 17 | thermal\$4)) same ((lead adj zirconium | EPO; | |

| | Туре | Hits | Search Text | DBs | Time Stamp |
|----|------|------|--|--|------------------|
| 25 | BRS | 83 | ((second! or another or addition\$ or third) near2 (anneal\$4 or heat\$4 or thermal\$4)) same ((lead adj zirconium adj titanate) or PZT) | EPO; | 2004/12/22 16:07 |
| 26 | BRS | 98 | ((second! or another or addition\$ or third) near2 (anneal\$4 or heat\$4 or thermal\$4)) near8 ((ferroelectric or perovskite or PZT or (lead adj zirconium adj titanate))) | | 2004/12/22 16:07 |
| 27 | BRS | 8,0 | S27 and ((@ad<"20001220") or | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:19 |
| 28 | IS&R | 880 | (438/239).CCLS. | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:19 |

| | Туре | Hits | Search Text | DBs | Time Stamp |
|----|------|------|-----------------|--|------------------|
| 29 | IS&R | 1479 | (438/3).CCLS. | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 16:20 |
| 30 | IS&R | 1193 | (438/240).CCLS. | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | |
| 31 | IS&R | 107 | (438/957).CCLS. | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | |

| | L # | Hits | Search Text | DBs | Time Stamp |
|---|-----|--------|---|------------|---------------------|
| 1 | L1 | 602030 | capacitor | 1.1 P(1) • | 2004/12/22 15:37 |
| 2 | L2 | 16158 | perovskite | 1.1P(1) • | 2004/12/22 15:37 |
| 3 | L3 | 2264 | second! adj anneal\$6 | 1.112(1) | 2004/12/22 15:37 |
| 4 | L4 | | (top adj electrode) or (top adj plate) or (upper adj electrode) | TPO • | 2004/12/22 15:37 |

| | L # | Hits | Search Text | DBs | Time Stamp |
|---|------------|-------------|-----------------------|--|---------------------|
| 5 | 11.6 | 485711 4 | temperature or degree | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 15:37 |
| 6 | L8 | 2589 | first adj anneal\$6 | | 2004/12/22 15:37 |
| 7 | L9 | 88 | L7 and L8 | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 15:37 |
| 8 | L 5 | 104 | | US- PGPUB; USPAT; EPO; JPO; DERWEN T; IBM_TD B | 2004/12/22 15:37 |

| | L # | Hits | Search Text | DBs | Time Stamp |
|---|-----|------|-------------|---------|---------------------|
| 9 | L7 | 104 | L5 and L6 | 1.10/10 | 2004/12/22 15:37 |

US-PAT-NO: 6528863

DOCUMENT-IDENTIFIER: US 6528863 B1

TITLE: Perovskite-containing composite material,

method of

manufacturing said material, electronic

component and

module

----- KWIC -----

Application Filing Date - AD (1): 19950322

Brief Summary Text - BSTX (9):

With regard to this, a method of manufacturing a thin film from a ferroelectric perovskite material is described, for example, in U.S. Pat. No.

5,198,269, the contents of which are hereby incorporated by reference; said

method comprising the following steps: a . providing a first substrate, b.

selecting a first sol-gel-perovskite precursor material, the crystallization of

this first sol-gel-perovskite precursor material to the perovskite phase being

insensitive to the first substrate and, after the heat treatment, the material

being isostructural relative to the second ferroelectric, perovskite thin-film

material, c. depositing a first layer of the selected sol-gelperovskite

precursor material, d. subjecting said first layer to a thermal treatment to

form a first ferroelectric, perovskite thin-film material, e. selecting a

second sol-gel-perovskite precursor material, the crystallization of this

second sol-gel-perovskite precursor material to the perovskite phase being

sensitive to the substrate, f. depositing a second layer of the selected

sol-gel-perovskite starting material, g. subjecting said second layer to a

thermal treatment to form a second ferroelectric, perovskite thin-film

material, the second layer of the second sol-gel-perovskite precursor

material, after heat treatment, having better perovskite crystallinity when deposited on the first layer than if it would have been deposited directly on the substrate and heat treated.

US-PAT-NO:

6787412

DOCUMENT-IDENTIFIER: US 6787412 B2

TITLE:

Dielectric element and method for fabricating

the same

----- KWIC -----

Detailed Description Text - DETX (122):

The series of steps from the application process to the second heat

treatment were repeated four times, thereby forming a Bi-based ferroelectric

thin film 8 having a thickness of 200 nm (FIG. 7).

Related Application Filing Date - RLFD (1): 20001113